XN04322G

Silicon NPN epitaxial planar type (Tr1) Silicon PNP epitaxial planar type (Tr2)

For switching circuits/digital circuits

■ Features

- Two elements incorporated into one package (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half

■ Basic Part Number

• UNR2222 + UNR2122

■ Absolute Maximum Ratings $T_a = 25$ °C

	Parameter	Symbol	Rating	Unit	
Tr1	Collector-base voltage	V _{CBO}	50	V	
	(Emitter open)				
	Collector-emitter voltage	V _{CEO}	50	V	
	(Base open)				
	Collector current	I _C	500	mA	
Tr2	Collector-base voltage	V_{CBO}	-50	V	
	(Emitter open)			110,	
	Collector-emitter voltage	V _{CEO}	-50	V	
	(Base open)		10° 10°		
	Collector current	I_{C}	-500	mA	
Overall	Total power dissipation	P_{T}	300	mW	
	Junction temperature	T _j	150	°C	
	Storage temperature	T _{stg}	-55 to +150	°C	

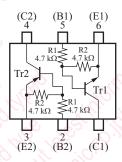
Package

- Code Mini6-G3
- Pin Name

1: Collector (Tr1) 4: Collector (Tr2) 2: Base (Tr2) 5: Base (Tr1) 3: Emitter (Tr2) 6: Emitter (Tr1)

■ Marking Symbol: 7V

■ Internal Connection





■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

• Tr1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_C = 10 \mu\text{A}, I_E = 0$	50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 2 \text{ mA}, I_B = 0$	50			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 50 \text{ V}, I_{E} = 0$			1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = 50 \text{ V}, I_{B} = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 6 \text{ V}, I_C = 0$			2	mA
Forward current transfer ratio	h_{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 100 \text{ mA}$	50			_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 100 \text{ mA}, I_B = 5 \text{ mA}$			0.25	V
Output voltage high-level	V _{OH}	$V_{CC} = 5 \text{ V}, V_B = 0.5 \text{ V}, R_L = 500 \Omega$	4.9			V
Output voltage low-level	V _{OL}	$V_{CC} = 5 \text{ V}, V_B = 3.5 \text{ V}, R_L = 500 \Omega$			0.2	V
Input resistance	R ₁		-30%	4.7	+30%	kΩ
Resistance ratio	R_1 / R_2		0.8	1.0	1.2	_
Transition frequency	f_{T}	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

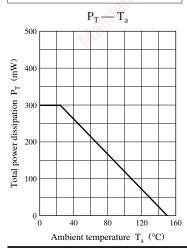
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

• Tr2

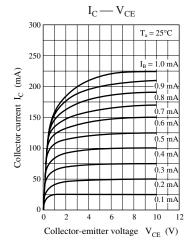
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V_{CBO}	$I_{\rm C} = -10 \ \mu \text{A}, \ I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = -2 \text{ mA}, I_B = 0$	-50			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = -50 \text{ V}, I_E = 0$			-1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = -50 \text{ V}, I_B = 0$	7		-1	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = -6 \text{ V}, I_C = 0$	1087		-2	mA
Forward current transfer ratio	h_{FE}	$V_{CE} = -10 \text{ V}, I_{C} = -100 \text{ mA}$	50	1,1	11,	<i>></i> '''
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -100 \text{ mA}, I_B = -5 \text{ mA}$	00,	100°	- 0.25	V
Output voltage high-level	V _{OH}	$V_{CC} = -5 \text{ V}, V_B = -0.5 \text{ V}, R_L = 500 \Omega$	-4.9) C	Ö	V
Output voltage low-level	V _{OL}	$V_{CC} = -5 \text{ V}, V_B = -3.5 \text{ V}, R_L = 500 \Omega$		-0/1/2	- 0.2	V
Input resistance	R_1	by the grant till a	-30%	4.7	+30%	kΩ
Resistance ratio	R_1 / R_2	18 CO 182	0.8	1.0	1.2	_
Transition frequency	f_T	$V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$	0.7	200		MHz

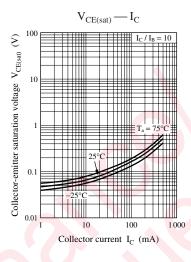
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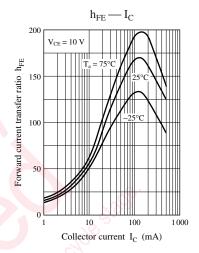
Common characteristics chart

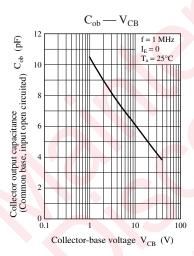


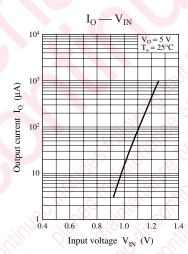
Characteristics charts of Tr1

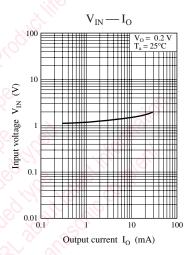




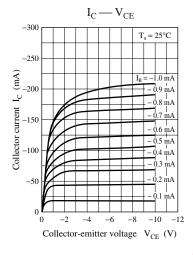


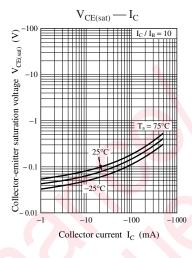


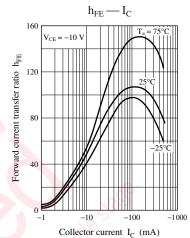


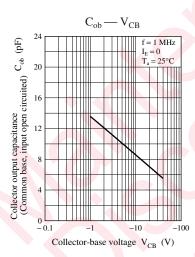


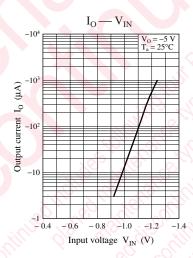
Characteristics charts of Tr2

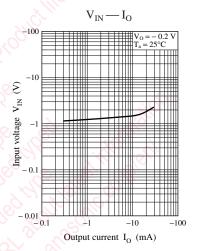




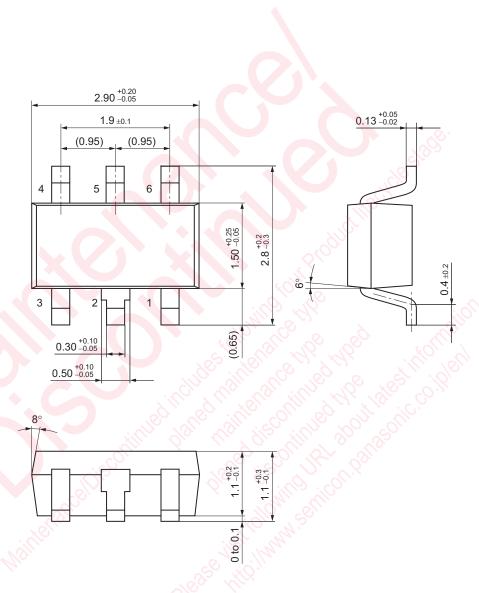








Mini6-G3 Unit: mm



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